Study of surface cleaning and Cs-activation on GaN photocathodes

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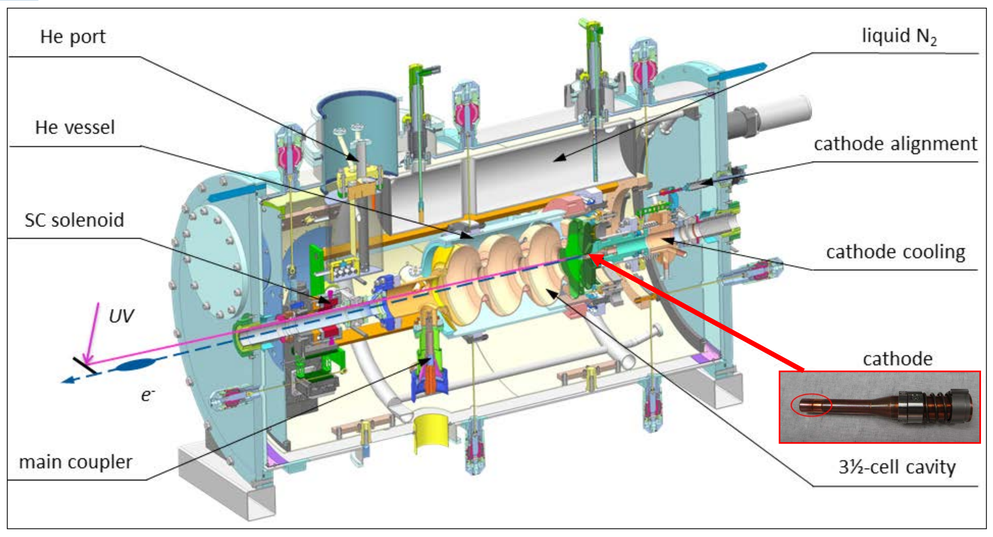
1. Introduction

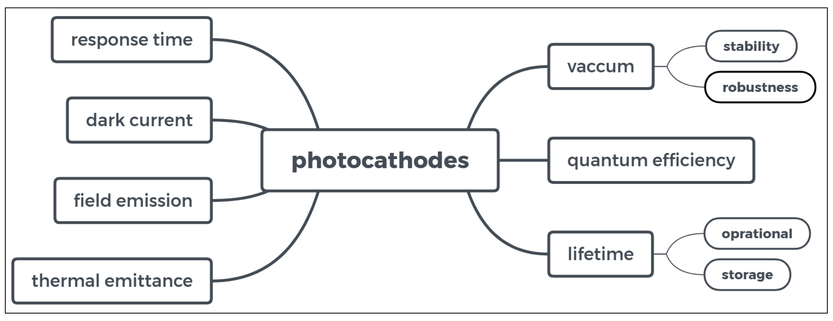
SRF Gun II



scheme of SRF gun II

desireable requirements for photocathodes

- searching for better photocathodes is one of the principle challenges for photoinjectors
- average current up to several mA is desireable
- novel III-V semiconductor with direct & wide band gap (3.4 eV)



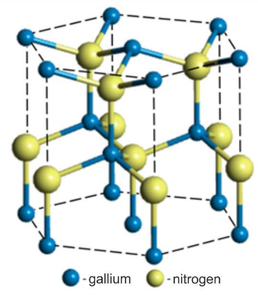
requirements for photocathodes used in accelerators

2. GaN (Cs)

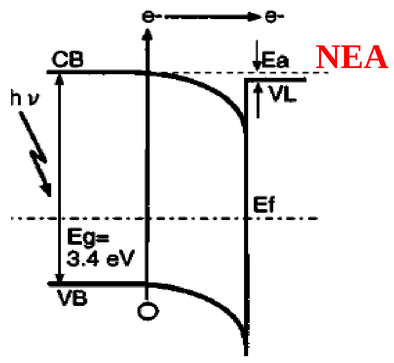
$$QE = \frac{N_{generated\ electrons}}{N_{incident\ photons}}$$

GaN properties

- high QE (~40%)
- working wavelength range of 150 nm- 400 nm
- negative electron affinity (NEA) → with Cs
- high robustness: resitant to vacuum contaminations
- good storage: ~3 years under nitrogen atmosphere



wurtzite structure of GaN



[S. Uchiyama., et al., APL 86, 103511 (2005)]

cesium activation & NEA

- Mg doping is necessary
  → increases diffusion length of e^- to surface
- activation with monolayer of Cs
  → work function near surface is lowered below vacuum level (NEA)

Table 1: Comparison of different photocathodes (for SRF Guns)

Property [Unit]	K_2CsSb	Cs_2Te	GaAs	Cu	Mg	GaN
harmonic *	2	4	2	4	4	3
λ [nm]	532	266	532	266	266	365
QE [%]	8	5	5	1.4E-2	0.5	~40
lifetime [hours]	4	> 100	~58	> 1 year	> 1 year	several years
response time [ps]	prompt	prompt	< 40	prompt	prompt	???
vacuum tolerance	poor	very good	poor	excellent	excellent	excellent

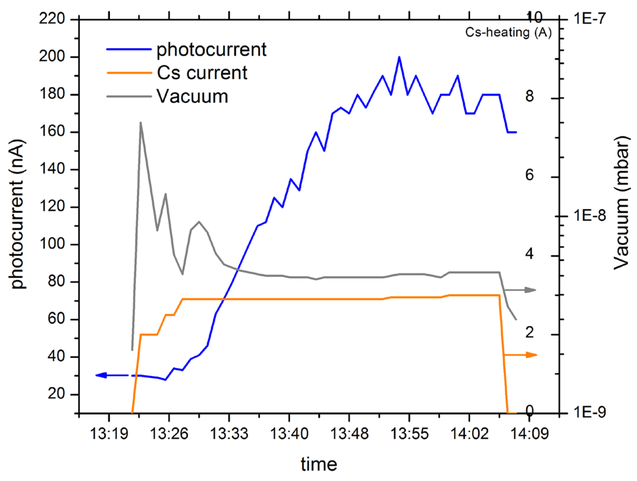
* For drive laser: Nd:YAG, output at 1064 nm

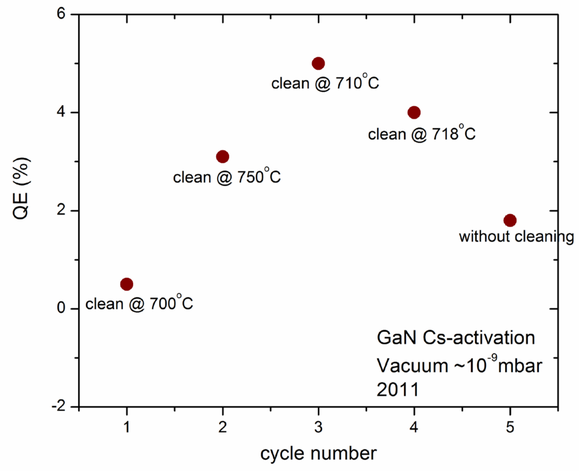
Introduction to the physics of electron emission, K.L.Jensen, 2017, p. 444 f.
Bazarov, Ivan V. et al. 2009. "Thermal Emittance and Response Time Measurements of a GaN Photocathode." Journal of Applied Physics 105(8).

GaN photocathode R&D

3. First activation treatments

- sample of 10^{17}-level p-doped GaN grown on silicon substrate
- pre-heat treatment to remove absorbed residual gases on GaN surface
- activated with Cs-dispenser (SAES) to achieve the NEA surface
- background vacuum in the test chamber droped down during activation



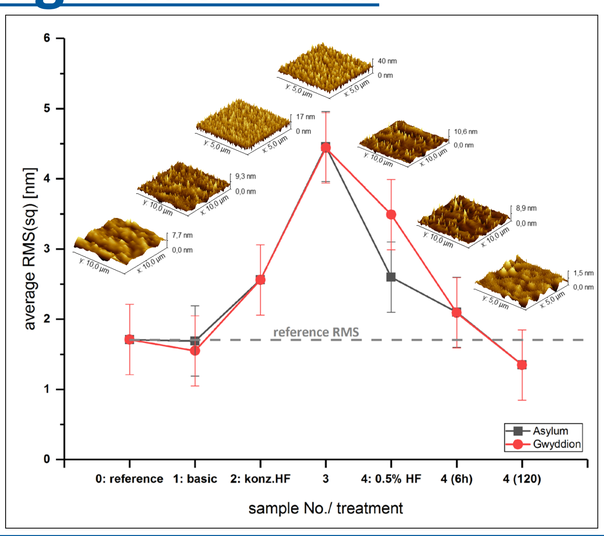


- 710°C seems suitable for the heat cleaning of GaN. 5% is the best QE in the activation tests on the same sample

& first cleaning treatments

Table 2: different wet chemical treating

sample No.	1	2	3	4
H_2SO_4:H_2O_2 (1:1), T ~140°C (15 min)	✓	✓	✓	✓
rinsed 2 x H_2O	✓	✓	✓	✓
40% HF (30 s)	-	✓	✓	-
0.5% HF (2 min)	-	-	✓	✓
H_2O rinsing tank (10 min)	-	-	✓	✓
EtOH & Benzol/Isopropanol (3:1) (1 min)	✓	-	✓	✓

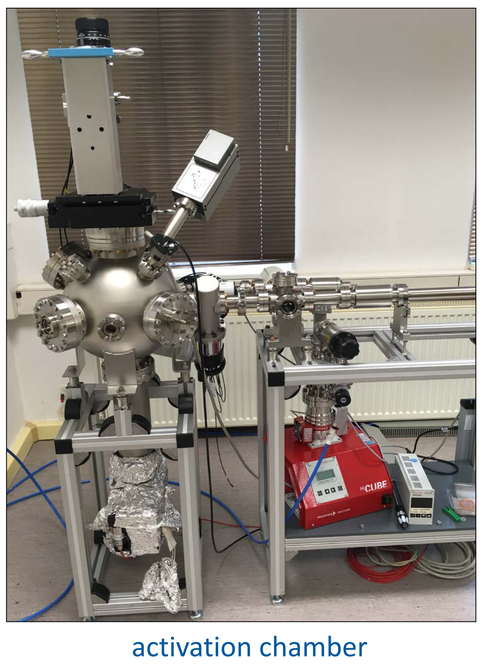


4. Ongoing working plan

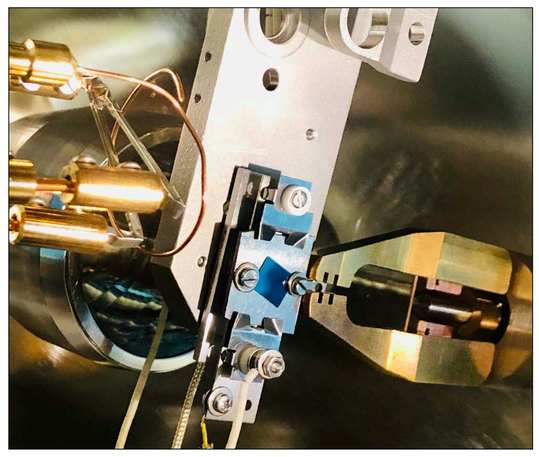
analytical chemistry

- SEM, TEM & AFM
- XRD, XPS & EDX
- RBS & AES
- PL & QE

- cleaning process of GaN wafer? (analytical surface chemistry)
- comparison of GaN on different substrate material
- Cs-activation processing
- chemical stability under intensive laser?
- processing in SRF Gun II?



activation chamber



inside view in activation chamber

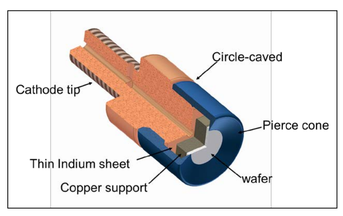
Modification of activation chamber

combination with SEM/EDX

- easy measurement of activated GaN
- detect contaminations/ lattice impurities

sample changement

- easy handling
- transfer from glove box without air exposure



scheme of wafer holder

cathode (cathode body + plug)

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